RICOH

R5524x Series

USB HIGH-SIDE POWER SWITCH

NO.EA-188-190627

OUTLINE

The R5524x is a CMOS-based high-side MOSFET switch IC which conforms to the universal serial bus (USB) standard. The device is suitable for protecting a USB power source. By using an Nch MOSFET with low Onresistance (Typ. 100 m Ω) as a switching transistor, the device can provide low dropout voltage. Internally, the device consists of an overcurrent limiting circuit, a thermal shutdown circuit, an undervoltage lockout (UVLO) circuit and a reverse current protection circuit. The device also consists of an internal delay circuit to prevent the output of false flag signals caused by inrush current. To achieve simplification of layout design, the overcurrent detection accuracy has been improved. The R5524x is offered in a 5-pin SOT-23-5 package and a 6-pin DFN(PLP)1820-6 package which achieve the smallest possible footprint solution on boards where area is limited.

FEATURES

- N-channel MOS High-Side Switch IC
- Switch ON Resistance ······ Typ. 100 mΩ at 5 V Input
- Current Limit Threshold Min. 650 mA⁽¹⁾, Min. 1.25 A⁽²⁾
- Overcurrent Limit······ Min. 550 mA
- Flag Delay Time Typ. 20 ms
- Under-voltage Lockout (UVLO) Circuit
- Thermal Shutdown Circuit
- Reverse Current Protection Circuit
- Package SOT-23-5, DFN(PLP)1820-6⁽³⁾

APPLICATIONS

- PCs and PC Peripherals
- Digital Televisions (DTV)
- Set Top Boxes (STB)
- Printers
- PDA
- Game Consoles

⁽¹⁾ Only for R5524x001A/B, R5524x002A/B

⁽²⁾ Only for R5524N004A

⁽³⁾ Only for R5524K001x, R5524K002x

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■ SELECTION GUIDE

The overcurrent limit protection type, the current limit threshold and the auto discharge options⁽¹⁾ for the ICs are user-selectable options.

Selection Guide

Product Name	Package	Quantity per Reel	Pb Free	Halogen Free
R5524N00x*-TR-FE	SOT-23-5	3,000 pcs	Yes	Yes
R5524K00x*-TR	DFN(PLP)1820-6	5,000 pcs	Yes	Yes

x: Specify the combination of Overcurrent Limit Protection type and Current Limit Threshold.

- 1: Latch-off Type, Current Limit Threshold: Min. 650 mA
- 2: Constant Current Type, Current Limit Threshold: Min. 650 mA
- 4: Cosntant Current Type, Current Limit Threshold: Min. 1.25 A⁽²⁾

*: Specify auto-discharge options.

- A: Auto-discharge included
- B: Auto-discharge not included

⁽¹⁾ Auto-discharge function quickly lowers the output voltage to 0 V, when the chip enable signal is switched from the active mode to the standby mode, by releasing the electrical charge accumulated in the external capacitor.
⁽²⁾ Only for R5524N004A

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BLOCK DIAGRAMS









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PIN DESCRIPTIONS







R5524N (SOT-23-5) Pin Configuration

R5524K (DFN(PLP)1820-6) Pin Configuration

	R5524N	Pin	Descri	ption
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Pin No.	Symbol	Description	
1	VIN	Input Pin	
2	GND	iround Pin	
3	EN	Chip Enable Pin, Active-high	
4	FLG	Flag Pin, Open Drain Output	
5	VOUT	Output Pin	

R5524K Pin Description

KJJZ4K FIII L			
Pin No.	Symbol	Description	
1	VOUT	Output Pin	
2	NC	No Connection	
3	FLG	Flag Pin, Open Drain Output	
4	EN	Enable Pin, Active-high	
5	GND	Ground Pin	
6	VIN	Input Pin	

The exposed tab is substrate level (GND). It is recommended that the exposed tab be connected to the ground plane on the board or otherwise be left open.

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ABSOLUTE MAXIMUM RATINGS

Absolute Maximum Ratings

Symbol	Item		Rating	Unit
V _{IN}	Input Voltage		6.0	V
V _{EN}	Enable Pin Input Voltage		-0.3 to 6.0	V
V _{FLG}	Flag Pin Voltage		-0.3 to 6.0	V
IFLG	Flag Pin Current		14	mA
Vout	Output Pin Voltage		-0.3 to 6.0	V
IOUT	Output Current		Internally Contr	olled
PD	Power Dissipation ⁽¹⁾	SOT-23-5, JEDEC STD.51-7	660	mW
FD		DFN(PLP)1820-6, JEDEC STD.51-7	2200	mW
Tj	Junction Temperature Range		-40 to 125	°C
Tstg	Storage Temperature Range		−55 to 125	°C

ABSOLUTE MAXIMUM RATINGS

Electronic and mechanical stress momentarily exceeded absolute maximum ratings may cause permanent damage and may degrade the lifetime and safety for both device and system using the device in the field. The functional operation at or over these absolute maximum ratings is not assured.

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Rating	Unit
V _{IN}	Operating Input Voltage	2.7 to 5.5	V
Та	Operating Temperature Range	−40 to 85	°C

RECOMMENDED OPERATING CONDITIONS

All of electronic equipment should be designed that the mounted semiconductor devices operate within the recommended operating conditions. The semiconductor devices cannot operate normally over the recommended operating conditions, even if they are used over such conditions by momentary electronic noise or surge. And the semiconductor devices may receive serious damage when they continue to operate over the recommended operating conditions.

⁽²⁾ Refer to POWER DISSIPATION for detailed information.

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ELECTRICAL CHARACTERISTICS

The specifications surrounded by \square are guaranteed by design engineering at $-40^{\circ}C \le Ta \le 85^{\circ}C$.

5524xxxxA/B Electrical Characteristics (Ta = 25°C					25°C)		
Symbol	Item	Item Conditions		Min.	Тур.	Max.	Unit
VIN	Input Voltage			2.7		5.5	V
DD1	Supply Current (Active Mode)	Vout = OPEN, El	N = "H", V _{IN} = 5 V		110	180	μA
IDD2	Supply Current (Standby Mode)	Vout = OPEN, El	N = "L", V _{IN} = 5 V		0.1	1.0	μA
Ron	Switch On Resistance	VIN = 5 V, IOUT = 5	500 mA		100	150	mΩ
ton	Output Turn-on Delay	$V_{IN} = 5 V, R_L = 60$) Ω		400		μs
toff	Output Turn-off Delay	$V_{IN} = 5V, R_L = 60$	Ω		50		μs
Vuvlo	UVLO Release Voltage	VIN Rising		2.3	2.5	2.7	V
V _{HYS}	UVLO Hysteresis Range	V _{IN} Falling			0.1		V
		R5524x001A/B R5524x002A/B	V _{IN} = 5 V	650	800	980	mA
Ітн	Current Limit Threshold		$V_{IN} = 5 V$	1.25	1.55	1.85	А
		R5524N004A	V _{IN} = 5 V, 0°C ≤ Ta ≤ 70°C	1.2	1.55	1.9	
I _{LIM}	Overcurrent Limit	$V_{IN} = 5 V$, After 5 ms from when $V_{OUT} = 0 V^{(1)}$		550	650	800	mA
tfd	Flag Delay Time ⁽²⁾	$V_{IN} = 5 V$, From when overcurrent detection until when FLG = "L"		7	20	30	ms
T_{TSD}	Thermal Shutdown Temperature	Junction Temperature			135		°C
T _{TSR}	Thermal Shutdown Released Temperature	Junction Temperature			120		°C
IEN	Enable Pin Input Current				0.01	1.0	μA
V _{EN1}	Enable Pin Input Voltage 1	V _{EN} Rising		2.0		6.0	V
V_{EN2}	Enable Pin Input Voltage 2	V _{EN} Falling		-0.3		0.8	V
Ilo	Output Leakage Current				0.1	1.0	μA
V_{LF}	Flag "L" Output Voltage	I _{SINK} = 1 mA				0.4	V
IFOF	Flag Off Current	V _{FLG} = 5.5 V			0.01	1.0	μA
IREV	Reverse Leakage Current	VIN = 0 V, VOUT =	5.5 V			50	μA
RLOW	Nch. On-resistance for Auto Discharge (R5524x00xA only)				450		Ω

All test items listed under Electrical Characteristics are done under the pulse load condition (Tj \approx Ta = 25°C) except Thermal Shutdown Temperature and Thermal Shutdown Released Temperature.

⁽¹⁾ Refer to "Overcurrent limit Function" in THEORY OF OPERATION for details.

⁽²⁾ Flag Delay Time is dependent on Input Voltage.

THEORY OF OPERATION

Overcurrent Limit Function

The R5524x001A/001B has the built-in latch-off type over-current limit circuit. When the over-current is detected, the protection circuit becomes active and the switch-transistor is turned OFF. The latch function is released if the input voltage value is exceeded in the release threshold of the UVLO circuit value after when it became lower than the detection threshold of the UVLO circuit value; or the EN pin set to the enabling condition again after set to the disabling condition.

If the over current condition occurred when the input voltage value was close to the minimum operating input voltage value. Under this condition, the voltage descends by the parasitic impedance on the power supply side, and it might fall below the detection threshold of the UVLO circuit. In this case, the switch-transistor is turned OFF and because of that the voltage drop of power line's parasitic impedance stops; the latch function is released with the UVLO and it becomes the over current condition again. The switch transistor keeps continual ON and OFF until one of the following is done; increasing the input voltage value; the setting of EN pin is disabling; or reducing the value of load current.

Moreover, the supply-voltage changed by the load-current dramatically changed depends upon the parasitic impedance of the wiring on the load side or the power supply side. Due to this, decreasing the parasitic impedance by the wiring on board is recommended.

The switch transistor of the R5524x001A/001B is turned OFF when the latch-off-function operates under the condition of the load of the constant current as the load device, such as the electronic load and so on, connecting with the Vout pin of the R5524x001A/001B. Because the load device keeps the constant current, the Vout pin voltage may become negative potential. If the Vout pin is exceed the absolute maximum rating may cause the permanent damages to the device, please avoid using in this situation.

The R5524x002A/002B and R5524N004A have the built-in over current protection circuit as the constant current type. It detects as the over-current condition, if the current flows as the ITH defined. Then operating the switch transistor to limit the output current to be the constant current defined by the ILIM.

If the condition of the over-current limit caused by the V_{OUT} pin clamped to the GND were continued the temperature of the ICs would increase drastically. The switch-transistor is turned OFF if the temperature of the ICs becomes over 135°C (Typ.). And after this, the switch-transistor is turned ON again when the temperature of ICs decreased approximately 15°C. The switch-transistor keeps continual ON and OFF until either the switch is turned OFF or the V_{OUT} pin is removed from GND.

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Timing Chart

R5524xxxxA/B

Output On-time and Output Off-time



R5524x Timing Chart

R5524x001 A/B (Latch-off Type)

Flag Delay Time



R5524x001A/001B (Latch-off Type) Timing Chart

- (1) When the I_{OUT} is I_{TH} or less, the current is not limited.
- (2) Once the I_{OUT} reaches to $I_{\text{TH}},$ the I_{OUT} is limited by $I_{\text{LIM}}.$
- (3) When the I_{OUT} drops to I_{LIM} or less within the t_{FD} time, the current limit is released. The current is not limited until the I_{OUT} exceeds I_{TH} again.
- (4) When the I_{OUT} reaches to I_{TH} and it is limited by I_{LIM} for t_{FD} or more, the switch transistor turns off and V_{FLG} becomes "Low".

<u>R5524x</u>

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R5524x002A/B、R5524N0004A (Constant Current Protection Type)

R5524x002A/002B and R5524N004A (Constant Current Type) Timing Chart

- (1) When I_{OUT} is I_{TH} or less, the current is not limited.
- (2) Once the lout reaches to ITH, the lout is limited by ILIM.
- (3) When the I_{OUT} drops to I_{LIM} or less within the t_{FD} time, the current limit is released. The current is not limited until the I_{OUT} exceeds I_{TH} again.
- (4) When the I_{OUT} reaches to I_{TH} and it is limited by I_{LIM} for t_{FD} or more, the V_{FLG} becomes "Low".

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APPLICATION INFORMATION



R5524x Typical Reference Circuit

Precautions for Selecting External Components

Bypass Capacitor

A 0.1μ F to 1μ F bypass capacitor between the V_{IN} pin and the GND pin, close to the device, is recommended. This precaution reduces power supply transients that may cause ringing on the input.

Pull-up Resistor of FLG Pin

A 10 k Ω to 100 k Ω pull-up resistor is recommended for the FLG pin.

R5524x001A/001B

The R5524x001A/001B is equipped with a latch-off function which requires initialization before start-up.

Case 1: Start-up by EN Pin Control EN pin must be enabled with the delay of 10 µs or more against 90% of V_{IN} voltage rising edge.

Case 2: Start-up by EN Pin Tied to V_{IN} Pin Slew rate of V_{IN} must be 40 μ s/V or slower.

⁽¹⁾ FLG pin is Nch. Open Drain Output.

⁽²⁾ A 47 μF or more output capacitor is recommended. According to a USB standard, a 120 μF or more output capacitor is required.

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TYPICAL CHARACTERISTICS

Note: Typical Characteristics are intended to be used as reference data; they are not guaranteed.



3) Switch ON Resistance vs. Temperature



5) Output ON Time vs. Temperature





4) Switch ON Resistance vs. Input Voltage



6) Output ON Time vs. Input Voltage



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7) UVLO Voltage vs. Temperature



9) Current Limit Threshold vs. Temperature (001x/ 002x)





1.52 1.5 1.48 1.46 1.46 1.46 1.44 1.42 1.42 1.42 1.42 1.42 1.42 1.44 1.42 1.42 1.44 1.42 1.48 1.48 1.42 1.48 1.48 1.42 1.48 1.42 1.43 1.42 1.43 1.44 1.42 1.43 1.44 1.42 1.43 1.44 1.42 1.43 1.44 1.38







8) Output Voltage vs. Input Voltage

5.5

5.0

4.5

4.0 3.5

3.0

2.5

2.0

1.5

1.0

0.5

Output Voltage Vour (V)

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13) Overcurrent Limit vs. Temperature





17) Enable Input Voltage vs. Temperature



14) Overcurrent Limit vs. Input Voltage











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19) Overcurrent Response with Ramped Load 20) Overcurrent Response with Ramped









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20) Overcurrent Response with Ramped Load



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23) Thermal Shutdown Operation





25) Output ON Time Response



27) Inrush current Characteristic



26) Output OFF Time Response



POWER DISSIPATION

SOT-23-5

Ver. A

The power dissipation of the package is dependent on PCB material, layout, and environmental conditions. The following measurement conditions are based on JEDEC STD. 51-7.

Measurement Conditions

ltem	Measurement Conditions	
Environment	Mounting on Board (Wind Velocity = 0 m/s)	
Board Material	Glass Cloth Epoxy Plastic (Four-Layer Board)	
Board Dimensions	76.2 mm × 114.3 mm × 0.8 mm	
Copper Ratio	Outer Layer (First Layer): Less than 95% of 50mm Square Inner Layers (Second and Third Layers): Approx. 100% of 50mm Square Outer Layer (Fourth Layer): Approx. 100% of 50mm Square	
Through-holes	φ 0.3 mm × 7 pcs	

Measurement Result

(Ta = 25°C, Tjmax = 125°C)

Item	Measurement Result
Power Dissipation	660 mW
Thermal Resistance (θja)	θja = 150°C/W
Thermal Characterization Parameter (ψjt)	ψjt = 51°C/W

θja: Junction-to-Ambient Thermal Resistance

wjt: Junction-to-Top Thermal Characterization Parameter





Measurement Board Pattern

SOT-23-5

Ver. A





POWER DISSIPATION

DFN(PLP)1820-6

Ver. B

The power dissipation of the package is dependent on PCB material, layout, and environmental conditions. The following measurement conditions are based on JEDEC STD. 51-7.

ltem	Measurement Conditions	
Environment	Mounting on Board (Wind Velocity = 0 m/s)	
Board Material	Glass Cloth Epoxy Plastic (Four-Layer Board)	
Board Dimensions	76.2 mm × 114.3 mm × 0.8 mm	
Copper Ratio	Outer Layer (First Layer): Less than 95% of 50 mm Square Inner Layers (Second and Third Layers): Approx. 100% of 50 mm Square Outer Layer (Fourth Layer): Approx. 100% of 50 mm Square	
Through-holes	φ 0.2 mm × 34 pcs	

Measurement Result

(Ta = 25°C, Tjmax = 125°C)

Item	Measurement Result
Power Dissipation	2200 mW
Thermal Resistance (θja)	θja = 45°C/W
Thermal Characterization Parameter (ψjt)	ψjt = 18°C/W

 $\boldsymbol{\theta} ja:$ Junction-to-Ambient Thermal Resistance

wjt: Junction-to-Top Thermal Characterization Parameter





Power Dissipation vs. Ambient Temperature

Measurement Board Pattern

PACKAGE DIMENSIONS

DFN(PLP)1820-6

Ver. B



UNIT: mm

DFN(PLP)1820-6 Package Dimensions

* The tab on the bottom of the package is substrate level (GND). It is recommended that the tab be connected to

the ground plane on the board, or otherwise be left floating.

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